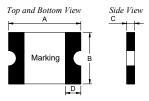
1, Physical Dimensions(size of 1206)

Unit:mm

-									
Part Number	A		В		С		D	Mouleino	
Part Number	Min	Max	Min	Max	Min	Max	Min	Marking	
K1206L200/12AR	3.00	3.50	1.40	1.80	0.80	1.30	0.25	T20	



2. Electrical Characteristics

Part Number	I _H (A)	I _T (A)	V _{max} (V)	I _{max} (A)	T _{trip} (Max time to trip) Current(A) Time(S)		Pd _{typ} (W)	R _{min} (Ω)	$R1_{max}$ (Ω)
K1206L200/12AR	2.00	4.00	12	100	8.00	1.00	0.70	0.020	0.120

I_H: Holding Current: maximum current at which the device will not trip in 25°C still air.

 I_T : Tripping Current minimum current at which the device will trip in 25 $^{\circ}$ C still air.

V_{max}: Maximum voltage device can withstand without damage at rated current.

 I_{max} : Maximum fault current device can withstand without damage at rated voltage.

T trip: Maximum time to trip(s) at assigned current.

Pd_{typ}: Rated working power.

R min: Minimum resistance of device prior to trip at 25°C.

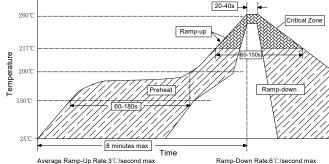
R1 max: Maximum resistance of device is measured one hours post reflow at 25°C.

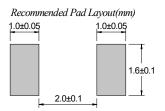
Noted: All electrical function test is conducted after PCB mounted.

3. Thermal Derating

K4206L200/42AD	Maximum ambient operating temperature									
K1206L200/12AR	-40°C	-20℃	0℃	25℃	40°C	50°C	60℃	70°C	85℃	
Hold Current(A)	2.88	2.61	2.28	2.00	1.80	1.66	1.51	1.39	1.19	
Trip Current(A)	5.76	5.22	4.56	4.00	3.60	3.32	3.02	2.78	2.38	

4. Solder Reflow Recommendations





Notes:If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

5. Package Information

Packing quantity:3500CS/Reel

Note:Reel packaging per EIA-481-1 standard

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